## Panasonic

Zener Diode DZ2704700L

### DZ2704700L Silicon epitaxial planar type

## For constant voltage / For surge absorption circuit DZ2S047 in SSSMini2 type package

#### Features

- · Excellent rising characteristics of zener current Iz
- Low zener operating resistance Rz
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

Marking Symbol: AJ

#### Packaging

Embossed type (Thermo-compression sealing) 10 000 pcs / reel (standard)

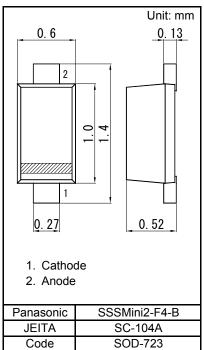
■ Absolute Maximum Ratings Ta = 25 °C

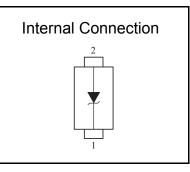
Parameter	Symbol	Rating	Unit
Repetitive peak forward current	IFRM	200	mA
Total power dissipation <sup>*1</sup>	PT	120	mW
Electrostatic discharge <sup>*2</sup>	ESD	±15	kV
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C

 
 Storage temperature
 Tstg
 -55 to
 +150
 °(

 Note)
 \*1: Mounted on glass epoxy print board. ( 45 mm x 45 mm x 1 mm) Solder in ( 0.4 mm x 0.3 mm)

\*2: Test method:IEC61000\_4\_2(C = 150 pF,R = 330 Ω, Contact discharge:10 times)





# ■ Electrical Characteristics Ta = 25 °C ± 3 °C Parameter Symbol Conditions Min Typ Max Unit Forward voltage VF IF = 10 mA 1.0 V

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Forward voltage	VF	IF = 10 mA			1.0	V
Zener voltage *1, *2	VZ	IZ = 5 mA	4.47		4.94	V
Zener operating resistance	RZ	IZ = 5 mA			80	Ω
Zener rise operating resistance	RZK	IZ = 1 mA			800	Ω
Reverse current	IR	VR = 1 V			2.0	μA
Temperature coefficient of zener voltage *3	SZ	IZ = 5 mA		0.5		mV/°C

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

2. Absolute frequency of input and output is 5 MHz.

3. \*1 The temperature must be controlled 25 °C for VZ mesurement.

VZ value measured at other temperature must be adjusted to VZ (25 °C)

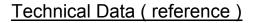
\*2 VZ guaranted 20 ms after current flow.

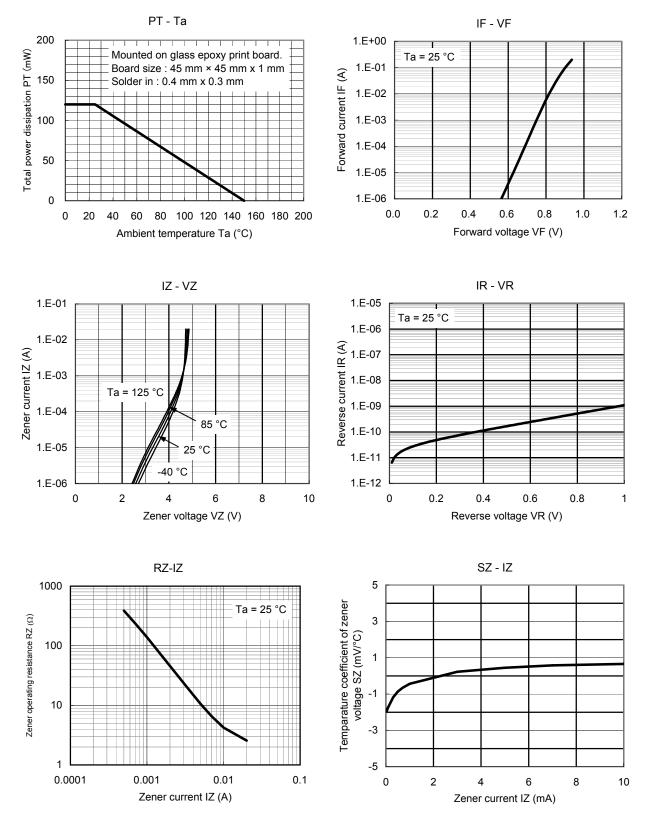
\*3 Tj = 25 °C to 150 °C





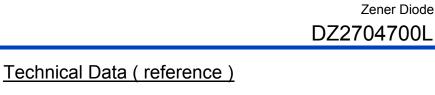
Zener Diode DZ2704700L

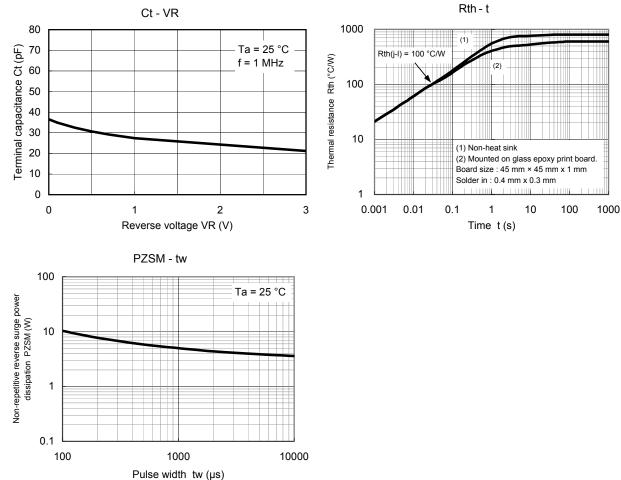




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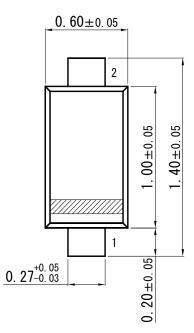


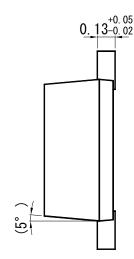


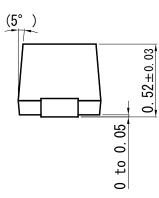
Zener Diode DZ2704700L

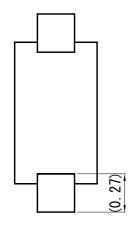
Unit: mm

SSSMini2-F4-B

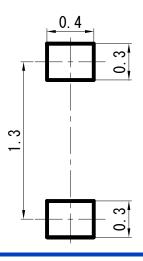












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